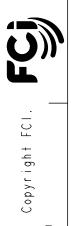
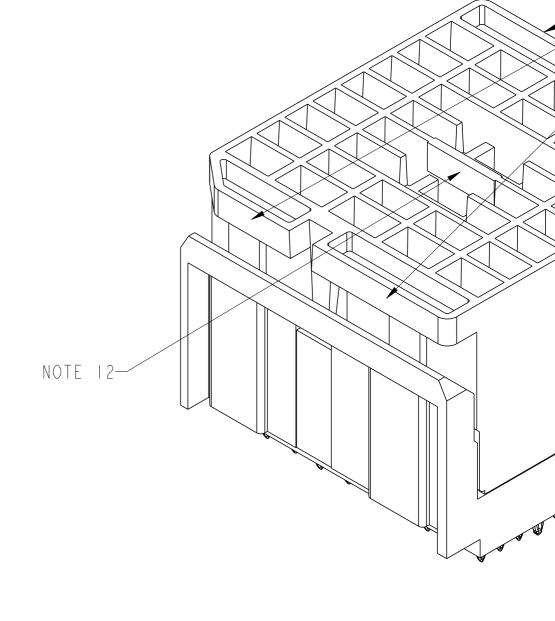
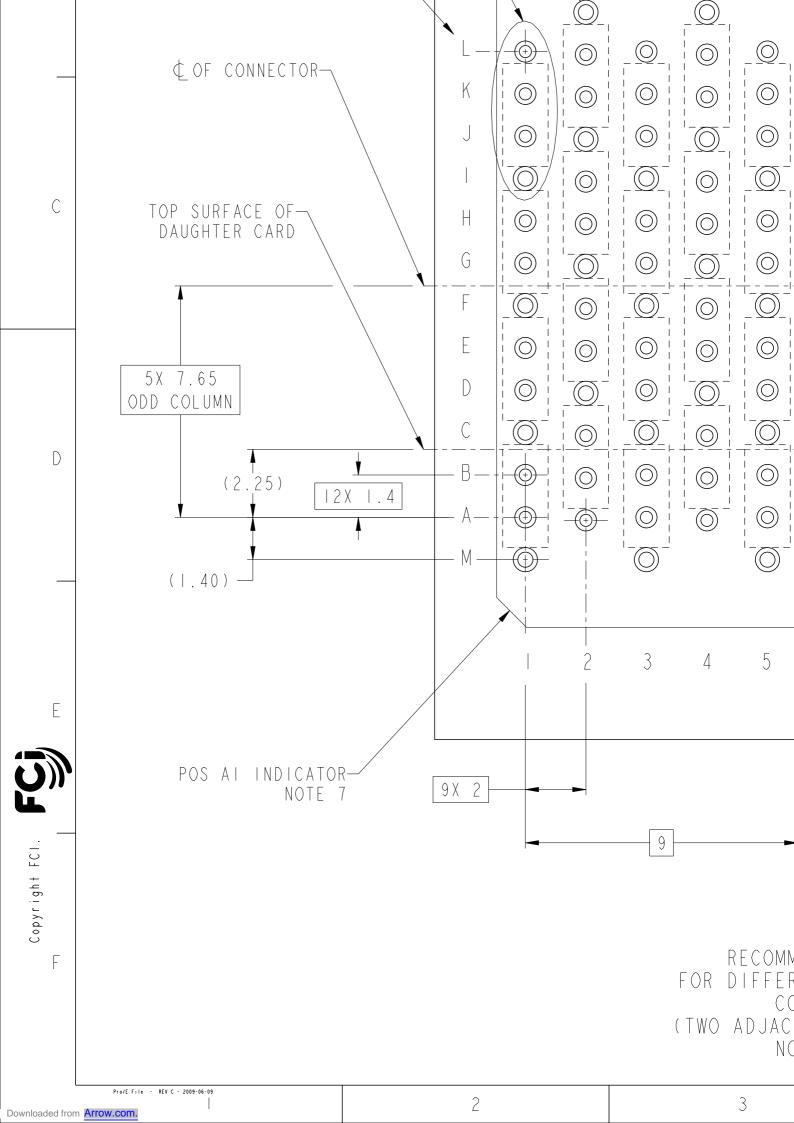


C

D







10123359-1021LF	YES	NO
	YES	YES

C

## NOTES:

I. CONNECTOR MATERIALS:

HOUSING: HIGH TEMP THERMOPLASTIC, BLACK, UL94V-0

CONTACT: COPPER ALLOY

2. CONTACT PLATING:

SEPARABLE INTERFACE: PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-XXX INCLUDING TELCORDIA GR-1217-CORE (NOVEMBER 1995) CENTRAL OFFICE TEST SEQUENCE PRESS-FIT TAILS: SEE TABLE

- 3. PRODUCT SPECIFICATION: GS-12-239.
- 4. APPLICATION SPECIFICATION: GS-20-035.
- (5) PRODUCT MARKING, (PROTOTYPE, PART NUMBER & LOT CODE), ON THIS SURFACE.
- 6.)THE MINIMUM CENTERLINE SPACING BETWEEN ADJACENT MODULES IS 20.0 mm.
- 7. CONNECTOR OUTLINE WITH HOUSING POS AT INDICATOR MAY BE SCREEN PRINTED ONTO CUSTOMER PCB TO BE USED AS A GUIDE FOR MANUAL CONNECTOR PLACEMENT.
- 8. REFER TO CUSTOMER DRAWING 10104444 FOR INFORMATION ON PCB HOLE DIAMETERS AND PLATING OPTIONS.
  - 9. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
    - 10. PACKAGING MEETS GS-14-920 LEAD FREE LABELING SPECIFICATION.
- II. FOR REMOVAL OF THE PROTECTIVE CAP BY HAND GRIP USING THESE SURFACES.
- (12) FOR REMOVAL OF THE PROTECTIVE CAP WITH PLIERS GRIP USING THIS FEATURE.
- GROUND VIAS IN POSITIONS C, F, I, & M FOR ODD COLUMNS AND POSITIONS D, G, J, & M FOR EVEN COLUMNS REQUIRE (\$\notinge 0.50) FINISHED HOLES. ALL OTHER VIAS REQUIRE (\$\notinge 0.40) FINISHED HOLES.
- THE OUTER VIAS IN COLUMN M ARE OPTIONAL. IF ADDED THESE HOLES PROVIDE GROUN SYMMETRY THROUGH THE PCB. NO CONNECTOR EONS WILL BE PRESSED INTO THESE HOLE
- (15) MATING PIN H5 IS 0.5mm LESS WIPE NOMINAL THAN THE SHOREST PIN.

D

F



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